

AeroZero® Thermal Tape AZ-PI Tape

Product Description

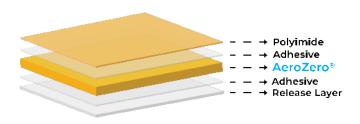
AZ-PI Tape consists of a 165 micron (6.5 mil)
AeroZero® polyimide aerogel film with a 25.4 micron (1 mil) external polyimide film joined with a 25.4 micron (1 mil) adhesive. The adhesive is a high-performance engineering grade silicone pressure sensitive adhesive (PSA) with a release layer that is peeled off before application to a substrate. Potential substrates include stainless steel, aluminum, glass, and polymer substrates such as polyimides, polyether ketones, polyurethanes, and polyesters. Typical use is thermal barrier/protection of parts in the Aerospace, Defense and Electronic industries.

Application

Prior to peeling the release liner from the adhesive, ensure the surface is clean and free of loose particles. Standard application temperature is 25 °C (77 °F) and the recommended set time for optimal adhesion is 3 days prior to testing. The minimum application temperature is 10 °C (50 °F) and minimum set time is 24 hours before performing any tests. Increasing temperature and dwell time may increase adhesion strength.

Features

- ♦ Ultra-thin thermal protection system (TPS)
- Lightweight
- ♦ RF transparent
- ♦ Flexibility enables use on complex parts
- ♦ Easy application with permanent bonding
- ♦ Flame retardant



Uses

- ♦ Launch vehicle protection
- Supersonic munition and aircraft
- High performance race cars and boats

Standard Dimensions

 \diamond Standard Roll: 25 mm wide x 7.6 m long (1 in x 25 ft)

Storage

Recommended Storage Conditions:

- Temperature: below 25 °C (77 °F)
- Relative Humidity: below 50%





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Physical and Mechanical Properties	Method	Value
Product Code	_	5010-1151-251
Thickness, µm (mil)	In-House Method	240 (9.5)
Tensile Strength, MPa (ksi)	ASTM D882-12	15 (2)
Young's Modulus, MPa (ksi)	ASTM D882-12	450 (65)
Tensile Elongation at Break, %	ASTM D882-12	8
Density, g/cm ³	In-House Method	0.58
Thermal Properties	Method	Value
Thermal Conductivity (25 °C), W/m•K	ASTM C518-10	0.046
Specific Heat Capacity (25 °C), J/g•°C	ASTM C1784-20	1.22
IR Emissivity (Polyimide Surface)	ASTM E408-13	0.85
Thermomechanical Properties	Method	Value
Glass Transition Temp (AZ T_g , DMA), °C (°F)	ASTM E1640-13	305 (580)
Decomposition Temp (10 wt% loss, TGA), °C (°F)	ASTM 2550-17	410 (770)
Additional Properties	Method	Value
Adhesive Strength:		
180 °peel/3 day-RT dwell time AZ film on 50.8 micron (2 mil) Al Foil (lb/in)	ASTM D3330	>200 (1.1)
UL Flammability Rating	UL94 VTM0	VTM-0
Data within this table are typical values for the AeroZero® polyimide TPS pro Product Code # 5010-11S1-251 Blueshift products are manufact	Polyimide (PI): 25.4 micron (1 Silicone Adhesive (PSA): 25.4 AeroZero (AZ): 165 micron (6.5 Silicone Adhesive (PSA): 25.4	micron (1 mil) 5 mil) micron (1 mil)